CSE 30321 - Lecture 01 - Introduction to CSE 30321

### Lecture 01 Introduction to CSE 30321

### Huh?

## All of the following are magazines that are regularly delivered to the Niemier household.







### You can learn about good routes to run if you're visiting Chicago...



### You can learn about the best ice cream...

road test | ICE CREAM POPS

#### joy sticks

Never send an adult to do a child's job. Real Simple gathered a group of funior gournands, ages five through 12 (plus a handful of their parents), and asked them to rate ice cream pops on a scale of "gross" to "awesome." After the feeding franzy, four frosty wonders remained. Here's what goored highest on the tasts-o-meter.





best take on a classic

HÄAGEN-DAZS VANILLA & MILK CHO-COLATE BAR Halled by one tester for 15 "rich, thick, and buttery" filling, this winner got points for how the "nice, chunky chocolate coating crackled in my mouth and melted into the vanilla." TO BUY: \$3.20 for three 3.67-ource bars.



POPSICLE CREAMSICLE

"Very refreshing," praised a panelist of this old-school icon. Said an eight-year-old: "Instea like frozen orange juice, but smooth because of the vanilla ice cream." TO BUY: \$3.30 for 12 1.65-ounce bars in two flavors. most decadent " ESCIMO PIE VANILLA RESTLÉ CRUNCH BAR "Crunchy and yumbu" is how one grade-schooler rated this ursåt. "The thin coating gets me to the lice cream Bas." Adults prilade the pop's "pleasing but not toor rich" Interfor. TO BUY: \$470r slx 3-ounce bars.



most virtuous THE SKINHY COW MINI FUDER BAR From the Intense flavor—"It tastas super chocolaty," raved an afticinado—jourd newer guess this pop packs only 50 calories. "Icy and rich" was the general consensus. To BUY 55 for 12.1.5-ounce bars.

#### how to stop brain freeze

Talk about a buzz kill: You're enjoying a delicious Slurpee or margarita when you get a piercing headache. This probably happens when capillaries in the roof of your mouth become dilated from coming into contact with an icy substance, says Mark W. Green, M.D., director of headache medicine at the **Columbia University** College of Dental Medicine, A message is then sent to your brain, and in response blood vessels can swell, resulting in a brain freeze. The cure? Simply press your tongue to the roof of your mouth to warm it, or drink a glass of warm water.



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### You can read about Pat Robertson and Al Sharpton advocating ways to reduce the effects of global climate change!



Rev. Al Sharpton and Rev. Pat Robertson, Virginia Beach, VA

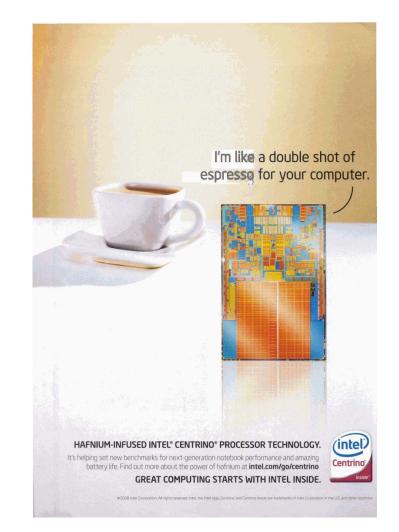
It's American to disagree. It's also American to come together in the face of a challenge. And few challenges are as urgent as global climate change. Take one minute to join us at uscansolveit.org and add your voice to millions of others. Together we can solve the climate crisis.



### If you're in the market for a wide-body jet, Boeing has just the thing...



# And if you're looking to buy a computer, Intel suggests their dual core Centrino chip...

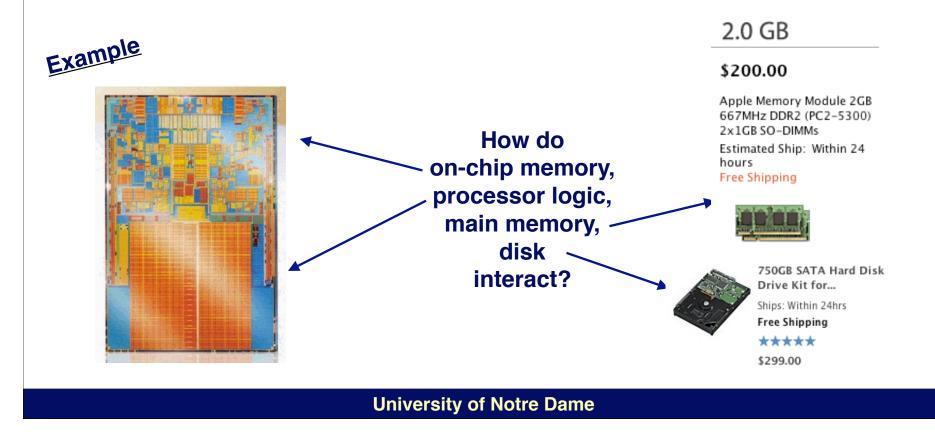


As you might guess, this brings us to CSE 30321...

In this ad, you're essentially looking at a picture of one of Intel's computer architectures...

... and computer architecture is what this class is about.

- At the end of the semester, you should be able to...
  - ...describe the fundamental components required in a single core of a modern microprocessor
    - (Also, explain how they interact with each other, with main memory, and with external storage media...)



• At the end of the semester, you should be able to...

Intel® Pentium® Dual-Core processor

everyday computing.

» Learn more

 ...compare and contrast different computer architectures to determine which one performs better...





ntel

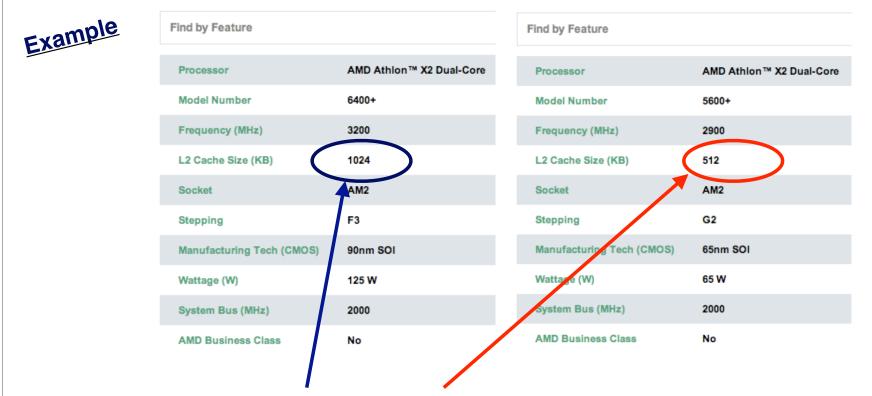
Processor	AMD Athlon™
Model	3200+
OPN Tray	ADA3200AEP5AR
OPN PIB	ADA3200BOX
Operating Mode 32 Bit	Yes
Operating Mode 64 Bit	Yes
Revision	00
Core Speed (MHz)	2000
Voltages	1.501
Max Temps (C)	70
Wattage	89 W
L1 Cache Size (KB)	128
L1 Cache Count	1
L2 Cache Size (KB)	1024
L2 Cache Count	1

	Learninore							
Processor Number <sup>1</sup>	Architecture	Cache	Clock Speed	Front Side Bus	Dual-core	Enhanced Intel SpeedStep® Technology <sup>2</sup>	Execute Disable Bit°	Intel® 64Φ
E2220	65 nm	1MB L2	2.40 GHz	800 MHz	1	1	1	1
E2200	65 nm	1MB L2	2 20 GH	800 MHz	1	1	1	1
E2180	65 nm	1MB L2	2.00 GHz	800 MHz	1	1	1	1
E2160	65 nm	1MB L2	1.80 GHz	800 MHz	1	1	1	1
E2140	65 nm	1MB L2	1.60 GHz	800 MHz	1	1	1	1
T2330	65 nm	1MB L2	1.60 GHz	533 MHz	1	1	1	1
T2310	65 nm	1MB L2	1.46 GHz	533 MHz	1	1	1	1
T2130	65 nm	1MB L2	1.86 GHz	533 MHz	1	1	1	
T2080	65 nm	1MB L2	1.73 GHz	533 MHz	1	1	1	
T2060	65 nm	1MB L2	1 00 6112	533 MHz	1	1	1	
T2370	65 nm	1MB L2	1.73 GHz	533 MHz	1	1	1	1

The Intel® Pentium® dual-core processor delivers great performance, low power enhancements, and multitasking for

If you want to do X, which processor is best?

- At the end of the semester, you should be able to...
  - ...design a processor architecture to meet a specific performance target...



You might choose to add more or less on-chip memory...

- At the end of the semester, you should be able to...
  - ...understand how code written in a high-level language (e.g. C) is eventually executed on-chip...



### In C:

```
void insertionSort(int numbers[], int array_size)
{
    int i, j, index;
    for (i=1; i < array_size; i++)
    {
        index = numbers[i];
        j = i;
        while ((j > 0) && (numbers[j-1] > index))
        {
            numbers[j] = numbers[j-1];
            j = j - 1;
        }
        numbers[j] = index;
    }
}
```

### In Java:

```
public static void insertionSort(int[] list, int length) {
    int firstOutOfOrder, location, temp;
```

for(firstOutOfOrder = 1; firstOutOfOrder < length; firstOutOfOrder++) {
 if(list[firstOutOfOrder] < list[firstOutOfOrder - 1]) {
 temp = list[firstOutOfOrder];
 location = firstOutOfOrder;</pre>

```
do {
    list[location] = list[location-1];
    location--;
}
while (location > 0 && list[location-1] > temp);
```

```
list[location] = temp;
```

Both programs could be run on the same processor... how does this happen?

} } }

### A tangent...

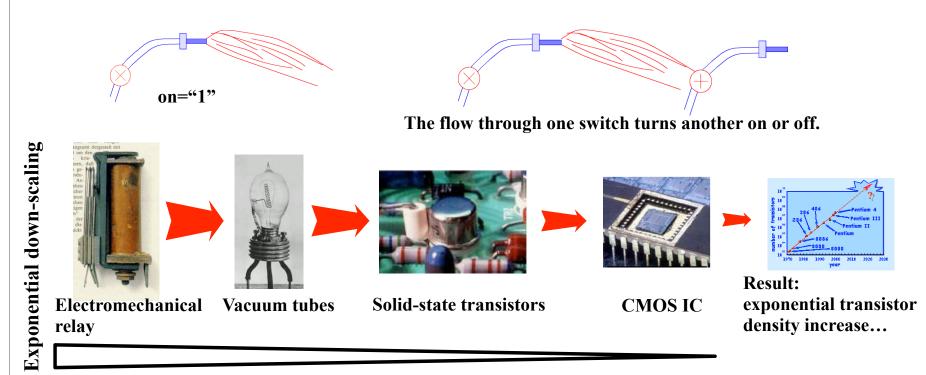
- We'll talk about 2 more course goals in a little bit, but right now, I'd like to ask the class a few questions...
  - Question 1:
    - How many people are EE, CPEG, CS, other?
  - Question 2:
    - By major, does anyone have any definitive thoughts about what they want to do after graduation?
  - Question 3:
    - Preface: last slide talked about SW...
    - How many people are more interested in the SW side of CSE than the HW side of CSE?
  - Question 4:
    - How many people view CSE 30321 as more a "HW course"
    - How many people think other more "SW oriented" courses are more relevant for their major?

## Let's digress...

- I asked the questions on the last slide not just to gauge interest, but to bring up an important point...
  - For last 20 years, if interested in SW, computer architecture was probably *not* the most important class for you.
- But...changes in technology are having a profound impact on conventional/established computer architectures
  - We're presently at the very beginning of this storm...
- We'll need significant engagement from programmers to continue the processor performance scaling trends of the last 40 years...
  - ... this will impact your career...

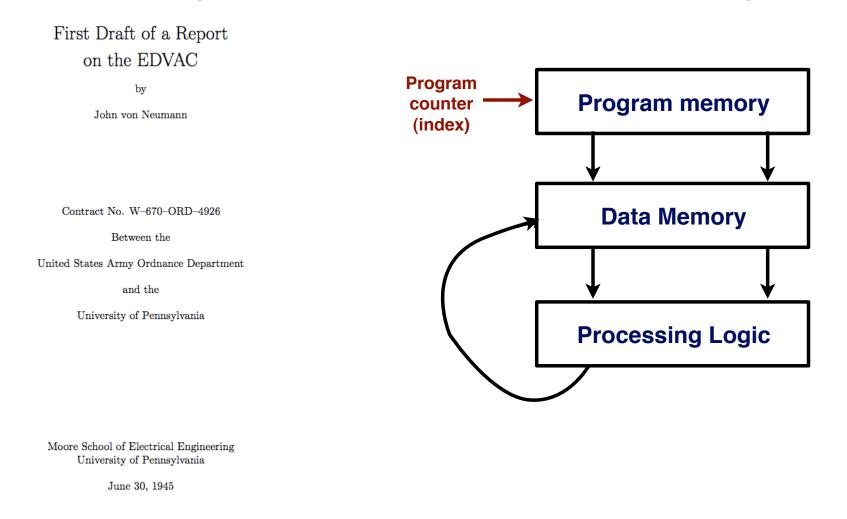
## A little history... Zuse's paradigm

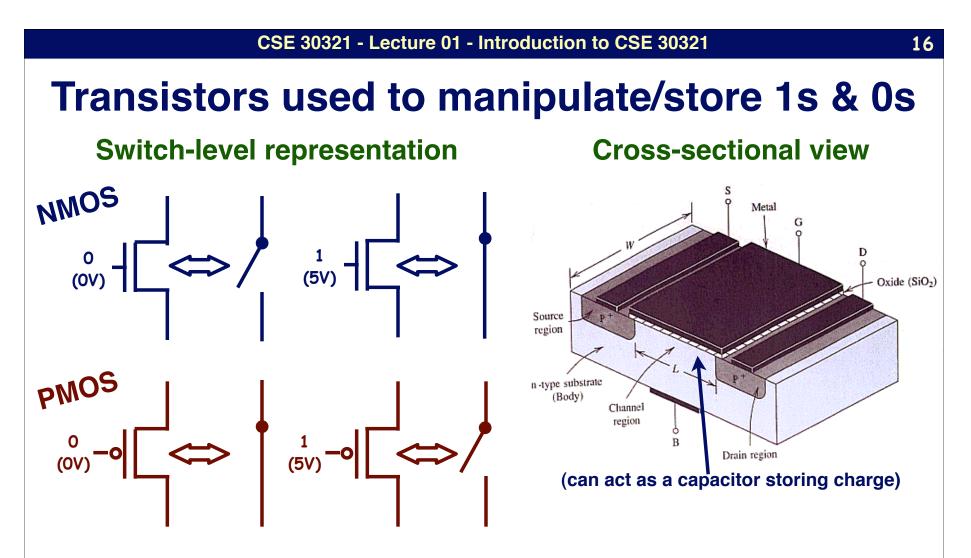
- Konrad Zuse (1938) Z3 machine
  - Use binary numbers to encode information
  - Represent binary digits as on/off state of a current switch



## A little history... programs

### Stored program model has been around for a long time...





Using above diagrams as context, note that (with NMOS) if we (i) apply a suitable voltage to the gate & (ii) then apply a suitable voltage between source and drain, current will flow.

## **Moore's Law**

"Cramming more components onto integrated circuits."

- G.E. Moore, Electronics 1965

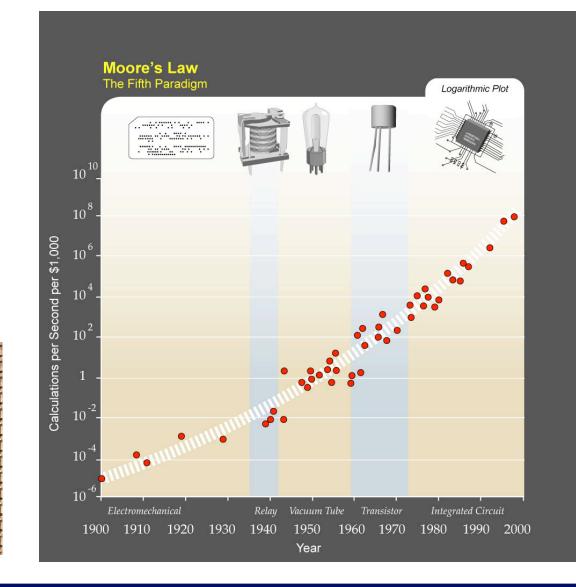
- Observation: DRAM transistor density doubles annually
  - Became known as "Moore's Law"
  - Actually, a bit off:
    - Density doubles every 18 months
    - (in 1965 they only had 4 data points!)

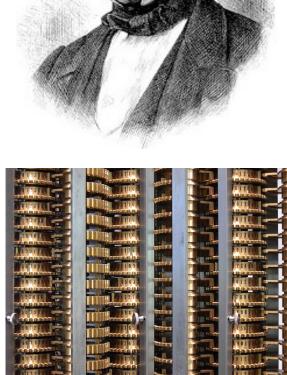
### - Corollaries:

- Cost per transistor halves annually (18 months)
- Power per transistor decreases with scaling
- Speed increases with scaling
- Reliability increases with scaling
  - Of course, it depends on how small you try to make things
    - » (I.e. no exponential lasts forever)

Remember these!

## **Moore's Law**





## **Moore's Law**

- Moore's Curve is a self-fulfilling prophecy
  - 2X every 2 years means ~3% per month
    - I.e. ((1 X 1.03) \* 1.03)\*1.03... 24 times = ~2
  - Can use 3% per month to judge performance features
  - If feature adds 9 months to schedule...it should add at least 30% to performance

- (1.03<sup>9</sup> = 1.30 ⇒ 30%)

## A bit on device performance...

- One way to think about switching time:
  - Charge is carried by electrons
  - Carrier velocity is proportional to the lateral E-field between source and drain
    - i.e. v = mE
      - m = carrier mobility (and can be though of as a constant)
  - Electric field defined as:  $E = V_{ds}/L$
  - Time for charge to cross channel = length/speed
    - (i.e. meters / (meters/s) = seconds)
    - $\cdot = L/v$
    - = L/(mE)
    - = L/(m\*(V<sub>ds</sub>/L))
    - = L²/(mV<sub>ds</sub>)

Thus, to make a device faster, we want to either increase V<sub>ds</sub> or decrease feature sizes (i.e. L)

## Some more important relationships

- What about power?
  - First, need to quickly discuss equation for capacitance:
    - $C_L = (e_{ox}WL)/d$ 
      - $e_{ox}$  = dielectric, WL = parallel plate area, d = distance between gate and substrate
  - Then, dynamic power becomes:
    - $P_{dyn} = C_L V_{dd}^2 f_{0-1}$ 
      - Dynamic power is a function of the frequency of 0 to 1 or 1 to 0 transitions (as this involves the movement of charge)
        - » Note frequency in this context is NOT clock frequency
      - Note that as W and L scale, C<sub>L</sub> decreases which in turn will cause a decrease in P<sub>dyn</sub>.
      - Note that while an increase in V<sub>dd</sub> will \*decrease\* switching time, it will also cause a quadratic \*increase\* in dynamic power.

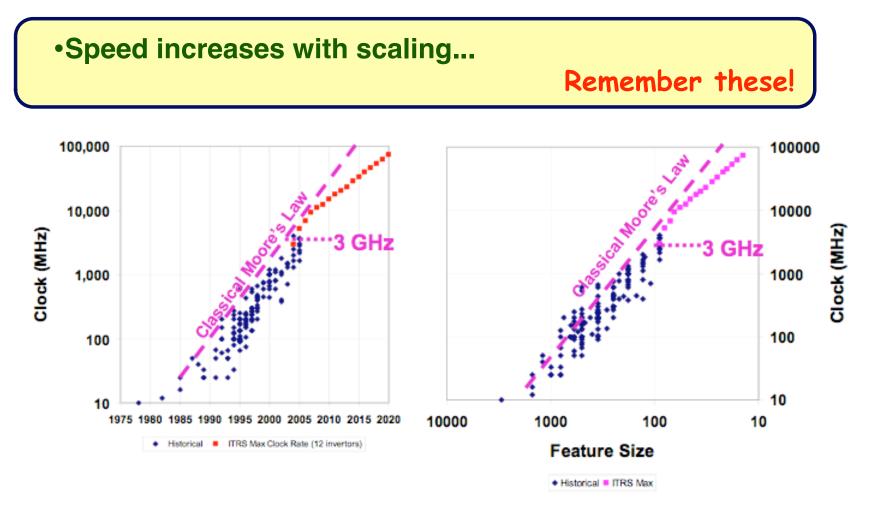
### Interconnect plays a role too...

### **Interconnect Power Dissipation**

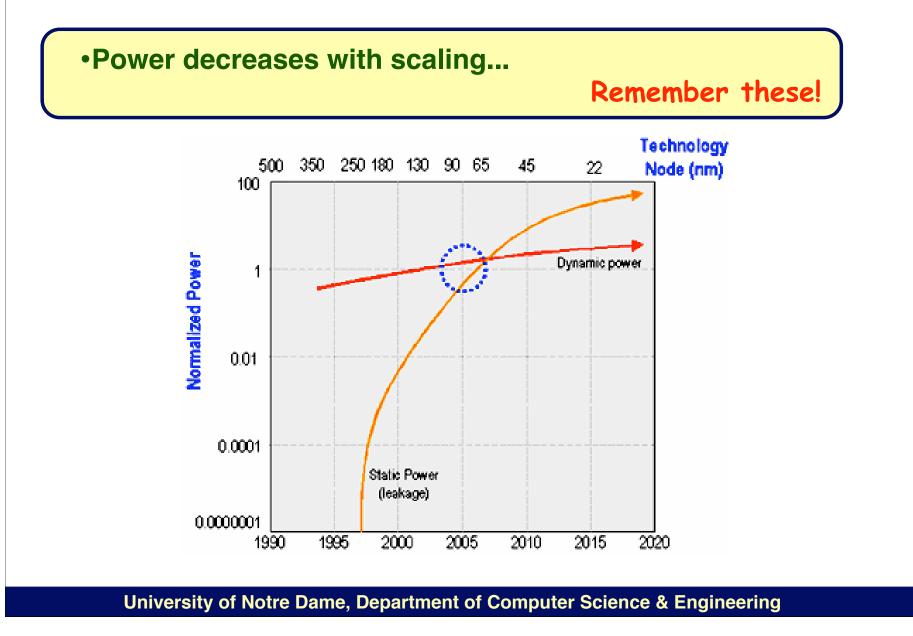
Power dissipation is arguably the most critical problem in high-performance chip design 100 2005] Power (Watts) 10 Over last two decades . ا • microprocessor power et o dissipation grows exponentially and primary contribution from [Horowitz interconnects 85 87 89 91 93 95 97 99 01 03 Year **Total power** Interconnect power Interconnect responsible for 80.9 global signals 34% 50% of 80.9 10.96 Gate dynamic power global clock 34% 60% 19% 50 W dissipation Interconnect 51% Local signals 40% 27% [Magen et al., 2004] 30 % 20.9 Diffusion 20 % Local clock 15% 10.% COLUMBIA UNIVERSITY 

### CSE 30321 - Lecture 01 - Introduction to CSE 30321

### A funny thing happened on the way to 45 nm



2005 projection was for 5.2 GHz - and we didn't make it in production. Further, we're still stuck at 3+ GHz in production.



Power decreases with scaling...

Remember these!

This is not the trend that you want to see:

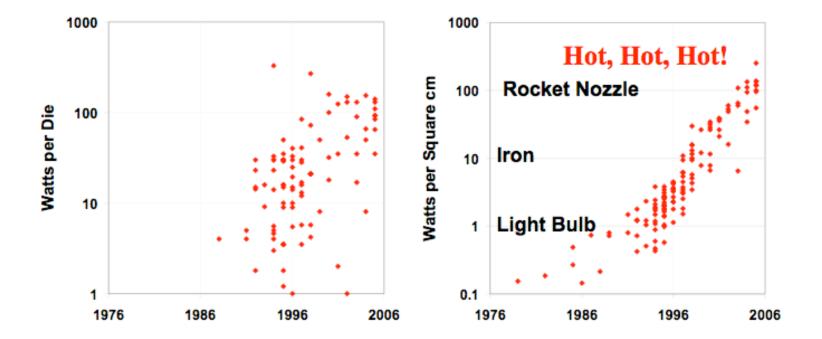
Decreasing Supply Voltage, Increasing Power

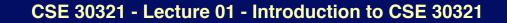
YEAR         2004         2007         2010         2013         2016           TECHNOLOGY         90 nm         65 nm         45 nm         32 nm         22 nm           CHIP SIZE         550 mm²         550 mm²         550 mm²         550 mm²         550 mm²           NUMBER OF TRANSISTORS         553 M         1 Billion         2 Billion         4.5 Billion         8.5 Billion           DRAM CAPACITY         1.0 Gbits         2.0 Gbits         4.3 Gbits         8.5 Gbits         35 Gbits           MAXIMUM CLOCK FREQUENCY         4.1 GHz         9.3 GHz         15 GHz         23 GHz         40 GHz           MAXIMUM CLOCK FREQUENCY         0.9 V         0.8 V         0.7 V         0.6 V         0.5 V           MAXIMUM POWER DISSIPATION         150 W         190 W         200 W         200 W         200 W           MAXIMUM POWER OF I/O PINS         3000         4000         4000         5300         7000						
CHIP SIZE550 mm²550 mm²550 mm²550 mm²NUMBER OF TRANSISTORS (LOGIC)553 M1 Billion2 Billion4.5 Billion8.5 BillionDRAM CAPACITY1.0 Gbits2.0 Gbits4.3 Gbits8.5 Gbits35 GbitsDRAM CAPACITY1.0 Gbits2.0 Gbits4.3 Gbits8.5 Gbits35 GbitsMAXIMUM CLOCK FREQUENCY4.1 GHz9.3 GHz15 GHz23 GHz40 GHzMINIMUM SUPPLY VOLTAGE0.9 V0.8 V0.7 V0.6 V0.5 VMAXIMUM POWER DISSIPATION150 W190 W200 W200 W200 WMAXIMUM NUMBER OF30004000400053007000	YEAR	2004	2007	2010	2013	2016
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SUPPLY VOLTAGE         0.9 V         0.8 V         0.7 V         0.6 V         0.5 V           MAXIMUM POWER DISSIPATION         150 W         190 W         200 W         200 W         200 W           MAXIMUM NUMBER OF         3000         4000         4000         5300         7000	CLOCK	4.1 GHz	9.3 GHz	15 GHz	23 GHz	40 GHz
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NUMBER OF 3000 4000 4000 5300 7000	POWER	150 W	190 W	200 W	200 W	200 W
	NUMBER OF	3000	4000	4000	5300	7000

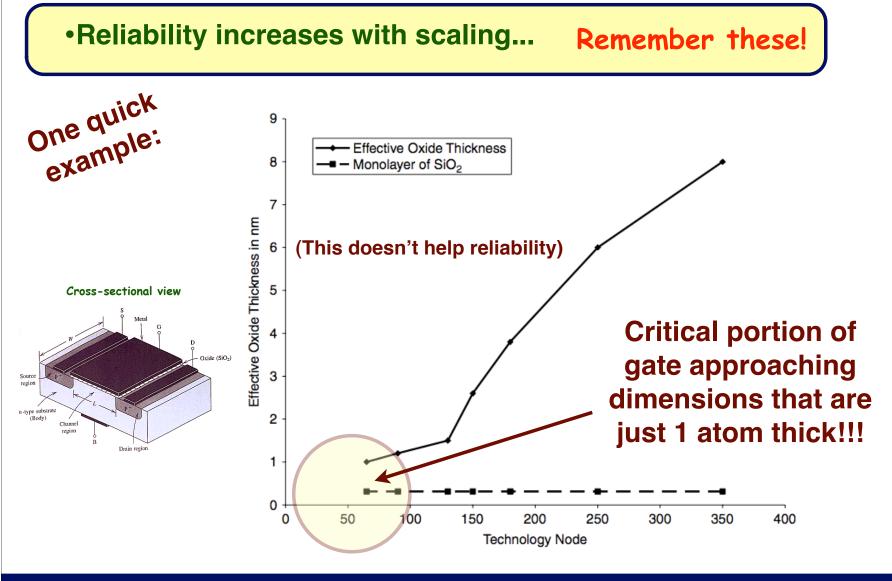
- Speed increases with scaling...
- Power decreases with scaling...

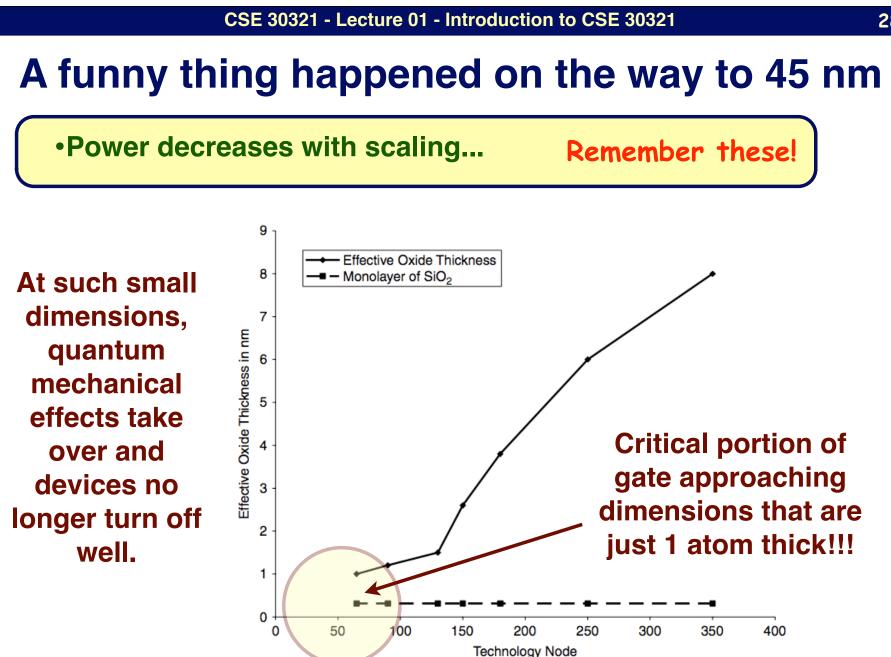
**Remember these!** 

### Why the clock flattening? POWER!!!!









### **Transistors used for memory too...**



Saw earlier, that transistors used for *on chip* memory too... Problem: Program, data = bigger + power problem isn't going away...



- Why? Put faster memory closer to processing logic...
  - SRAM (logic): density +25%, speed +20%
  - DRAM (memory): density +60%, speed +4%
  - Disk (magnetic): density +25%, speed +4%
  - Network interface: 10 Mb/s ⇒ 100 Mb/s ⇒ 1 Gb/s

### Solution?

### High art meets high-tech.

Lincoln's latest project, titled "CUBE," is a 10' x 10' translucent structure outfitted with video cameras, uniquely combining sculpture, portraiture and architecture. With **Intel® Centrino® processor technology** inside, a notebook becomes many other things as well — portable studio, canvas, inspiration tool.

#### **Top 5 Must-Haves**

#### POWERFUL PROCESSOR

A portrait of performance. "My generative portraits are demanding on the processors in my laptop, as they continuously manipulate video," says Lincoln. Thankfully, the **dual-core performance** of Intel Centrino processor technology can handle intensive tasks with flying colors.

#### DIZZYING TRANSFER SPEEDS

Art (at 30 frames per second). Data transferring up to 20% faster<sup>1</sup> allows Lincoln to store footage from 24 video cameras with lightning speed

#### HIGH-SPEED WIRELESS

Always Connected. With up to twice the range and 5x the speed when connected to a Wireless N home network,<sup>2</sup> Lincoln can download music or shop for art books anywhere, anytime.

#### ENHANCED VIDEO

High-def (redefined). Lincoln can view his generative portraits with "gallerylike" clarity, thanks to stunning multimedia performance, for a super-enhanced high-def video.experience.

#### 

The power of art. Lincoln's infinitely reconfiguring images are ultimately presented on a plasma screen powered by his computer — so wasting power is not an option. Thanks to **Intel's exclusive power-saving features**, he conserves energy by using it only when he needs it.

> Deeper. Richer. Faster. Log on to drivenbywhatsinside.com for access to exclusive multimedia content to keep you up-to-date on the latest tect trends — faster. To take advantage of this high-tech, multimedia material, make sure your computer has Intel Centrino processor technology.

> 62030 Intel Corporation. All rights reserved. Intel, the Intel Corpora Centrino, and Centrino Inside are trademarks of Intel Corpora in the U.S. and other countries. '20% faster data transfer rate previous-generation Intel Centrino processors.'2 Up to 2x gre range and up to 5b better performance and improved batting with optional Intel<sup>®</sup> Next-Gen Windess M technology enable confidence and advised on your specific hardware, connection rate, performance/mobile/windess.'See http://www.intel.confidence.org Deck With your PC and access point manufacture for datals. Deck With your PC and access point manufacture for datals.

Motivation: Processor complexity is good enough, transistor sizes scale, we can slow processors down, manage power, and get performance from...

### **Parallelism**

### **Top 5 Must-Haves**

**POWERFUL PROCESSOR** 

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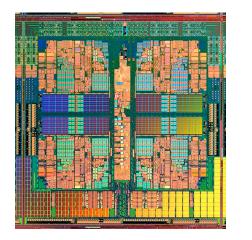
C RISSUMA SPAMEPER COPERC

### University of Notre Dame, Department of Computer Science & Engineering

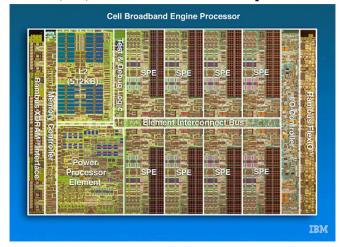
30

### This idea has been extended...

### Quad core chips...



7, 8, and 9 core chips...



When will it stop?



Practical problems must be addressed!



- At the end of the semester, you should be able to...
  - ...explain and articulate why modern microprocessors now have more than 1 core...
- Why?
  - For 8, 16 core chips to be practical, we have to be able to use them
    - Students in this class should go on to play a role in making such chips useful...

- At the end of the semester, you should be able to...
  - Apply fundamental knowledge about single core machines, dual core machines, performance metrics, etc. to design a microprocessor such that it (a) meets a target set of performance goals and (b) is realistically implementable.

## A few notes about Lecture 02 (guest lecture) (print out notes)

## Now, let's look at the syllabus